

# CMOS Two 4-Channel Analog Multiplexer/Demultiplexer

## FEATURES

- -3dB Bandwidth: 180MHz
- Single Supply Operation +2.5V to +5.5V
- Low ON Resistance, 48Ω(TYP) With 5V Supply
- High Off-Isolation: -83dB (RL = 50Ω, f = 1MHz)
- Break-Before-Make Switching
- Binary Address Decoding on Chip
- Operating Temperature Range: -40°C to +125°C
- PACKAGES: SOIC-16(SOP16), SSOP-16, TSSOP-16 and QFN-3x3-16L

## APPLICATIONS

- Sensors
- Analog and Digital Multiplexing and Demultiplexing
- A/D and D/A Conversion
- Signal Gating
- Battery-Operated Equipment
- Factory Automation
- Appliances
- Communications Circuits

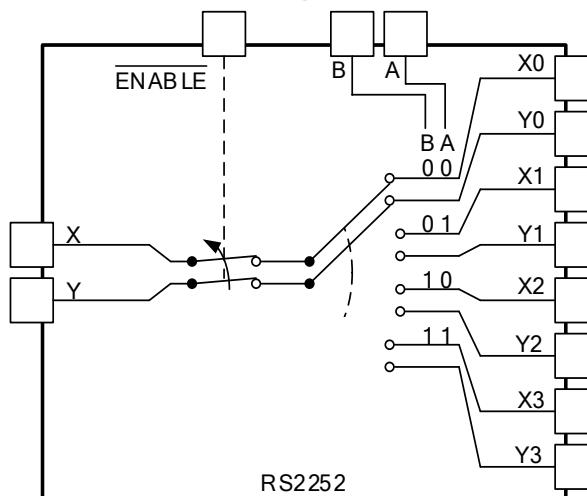
## DESCRIPTION

The RS2252 is a CMOS analog IC configured as two 4-channel multiplexers. This CMOS device can operate from 2.5 V to 5.5 V.

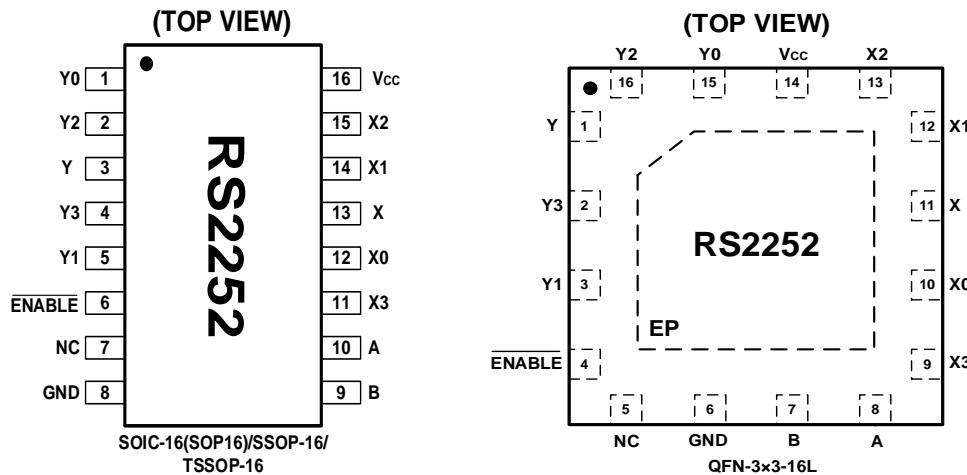
The RS2252 device are digitally-controlled analog switches. It has low on-resistance (48Ω TYP) and very low off-leakage current (1nA TYP).

The RS2252 is available in Green SOIC-16, SSOP-16, TSSOP-16 and QFN-3x3-16L packages. It operates over an ambient temperature range of -40°C to +125°C.

## Functional Diagrams of RS2252



## PIN CONFIGURATIONS



## PIN DESCRIPTION

NAME	PIN (SOIC-16/SSOP-16/TSSOP-16)	PIN (QFN-3×3-16L)	FUNCTION
X0-X3	12,14,15,11	10,12,13,9	Analog Switch Inputs X0-X3.
Y0-Y3	1,5,2,4	15,3,16,2	Analog Switch Inputs Y0-Y3.
X	13	11	Analog Switch "X" Output.
Y	3	1	Analog Switch "Y" Output.
V <sub>CC</sub>	16	14	Positive Analog and Digital Supply Voltage Input.
A	10	8	Digital Address "A" Input.
B	9	7	Digital Address "B" Input.
GND	8	6	Ground. Connect to digital ground.
NC	7	5	No Connect.
<u>ENABLE</u>	6	4	Digital Enable Input. Normally connected to GND.
EP	—	Exposed Pad	Exposed Pad. Connect EP to GND.

## FUNCTION TABLE

ENABLE INPUT	INPUT STATES		ON CHANNEL(S)
	B	A	
1	X	X	NONE
0	0	0	X0, Y0
0	0	1	X1, Y1
0	1	0	X2, Y2
0	1	1	X3, Y3

X=Don't care

NOTE: Input and output pins are identical and interchangeable. Either may be considered an input or output; signals pass equally well in either direction.

## SPECIFICATIONS

### Absolute Maximum Ratings

Over operating free-air temperature range (unless otherwise noted) <sup>(1)</sup>

SYMBOL	PARAMETER			MIN	MAX	UNIT	
V <sub>CC</sub>	Supply Voltage			-0.3	6	V	
V <sub>IN</sub>	Input Voltage (All inputs)			-0.3	V <sub>CC</sub> +0.3		
I <sub>IN</sub>	Switch Input Current	Any one input			-20	+20	mA
I <sub>PEAK</sub>	Peak Switch Current	Pulsed at 1ms Duration, <10% Duty Cycle			-40	+40	
T <sub>J</sub>	Junction Temperature				150	°C	
T <sub>STG</sub>	Storage temperature			-65	+150		

(1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied.

### ESD Ratings

			VALUE	UNIT
V <sub>(ESD)</sub>	Electrostatic discharge	Human-body model (HBM)	±4000	V
		Charged-device Model (CDM)	±1000	V

### Recommended Operating Conditions

Over operating free-air temperature range (unless otherwise noted) <sup>(3)</sup>

SYMBOL	PARAMETER			MIN	MAX	UNIT
V <sub>CC</sub>	Supply Voltage			2.5	5.5	V
T <sub>A</sub>	Operating temperature			-40	+125	°C

### Thermal Information

THERMAL METRIC		RS2252				UNIT	
		16 PINS					
		SOIC-16 (SOP-16)	SSOP-16	TSSOP-16	QFN3X3-16L		
R <sub>θJA</sub>	Junction-to-ambient thermal resistance	76	118.7	111.3	51.9	°C/W	
R <sub>θJC(top)</sub>	Junction-to-case(top) thermal resistance	42.1	66.4	45.3	53.3	°C/W	
R <sub>θJB</sub>	Junction-to-board thermal resistance	34.8	62.2	56.9	26.6	°C/W	
Ψ <sub>JT</sub>	Junction-to-top characterization parameter	26.9	20.9	5.4	1.7	°C/W	
Ψ <sub>JB</sub>	Junction-to-board characterization parameter	34.7	61.7	56.3	26.6	°C/W	
R <sub>θJC(bot)</sub>	Junction-to-case(bottom) thermal resistance	N/A	N/A	N/A	11.6	°C/W	

## PACKAGE/ORDERING INFORMATION

PRODUCT	ORDERING NUMBER	TEMPERATURE RANGE	PACKAGE LEAD	PACKAGE MARKING <sup>(1)</sup>	PACKAGE OPTION
RS2252	RS2252XS16	-40°C ~+125°C	SOIC-16(SOP16)	RS2252	Tape and Reel,4000
	RS2252XSS16	-40°C ~+125°C	SSOP-16	RS2252	Tape and Reel,4000
	RS2252XTSS16	-40°C ~+125°C	TSSOP-16	RS2252	Tape and Reel,4000
	RS2252XTQC16	-40°C ~+125°C	QFN-3x3 -16L	RS2252	Tape and Reel,5000

NOTE:

- (1) There may be additional marking, which relates to the lot trace code information(data code and vendor code), the logo or the environmental category on the device.

## ELECTRICAL CHARACTERISTICS

$V_{CC} = 5.0 \text{ V}$  or  $3.3\text{V}$ , FULL =  $-40^\circ\text{C}$  to  $+125^\circ\text{C}$ , Typical values are at  $TA = +25^\circ\text{C}$ . (unless otherwise noted)

PARAMETER	SYMBOL	CONDITIONS	$V_{CC}$	$T_A$	MIN	TYP	MAX	UNITS
<b>ANALOG SWITCH</b>								
Analog Signal Range	$V_{X\_}, V_X$ $V_{Y\_}, V_Y$			FULL	0		$V_{CC}$	V
On-Resistance	$R_{ON}$	$V_{CC}=5\text{V}, I_X, I_Y=1\text{mA}$	5V	+25°C		48	65	Ω
				FULL			70	Ω
		$V_{CC}=3.3\text{V}, I_X, I_Y=1\text{mA}$	3.3V	+25°C		100	130	Ω
				FULL			140	Ω
On-Resistance Match Between Channels	$\Delta R_{ON}$	$V_{CC}=5\text{V}, I_X, I_Y=1\text{mA}$ Switch ON	5V	+25°C		1.5	5	Ω
				FULL			5.3	Ω
On-Resistance Flatness	$R_{FLAT(ON)}$	$V_{CC}=5\text{V}, I_X, I_Y=1\text{mA}$ Switch ON	5V	+25°C		17	25	Ω
				FULL			28	Ω
X_Off, Y_Off, X Off, Y Off, X On, Y On Leakage Current	$I_{X\_OFF}, I_{Y\_OFF}$ $I_{X(OFF)}, I_{Y(OFF)}$ $I_{X(ON)}, I_{Y(ON)}$	$V_{CC}=5\text{V}, V_{X\_}, V_{Y\_}=1\text{V}, 4.5\text{V}$ $V_X, V_Y=4.5\text{V}, 1\text{V}$	5V	+25°C		1	100	nA
		$V_{CC}=3.3\text{V}, V_{X\_}, V_{Y\_}=1\text{V}, 3\text{V}$ $V_X, V_Y=3\text{V}, 1\text{V}$		3.3V	+25°C		1	100
<b>DIGITAL CONTROL INPUTS<sup>(1)</sup></b>								
Logic Input Logic Threshold High	$V_{AH}, V_{BH}, V_{ENABLE}$		5V	+25°C	1.7			V
				3.3V	+25°C	1.7		V
Logic Input Logic Threshold Low	$V_{AL}, V_{BL}, V_{ENABLE}$		5V	+25°C			0.5	V
				3.3V	+25°C		0.5	V
Input-Current High	$I_{AH}, I_{BH}, I_{ENABLE}$	$V_A, V_B, V_{ENABLE}=V_{CC}$	3.3V to 5V	+25°C		1	100	nA
Input-Current Low	$I_{AL}, I_{BL}, I_{ENABLE}$	$V_A, V_B, V_{ENABLE}=0\text{V}$	3.3V to 5V	+25°C		1	100	nA

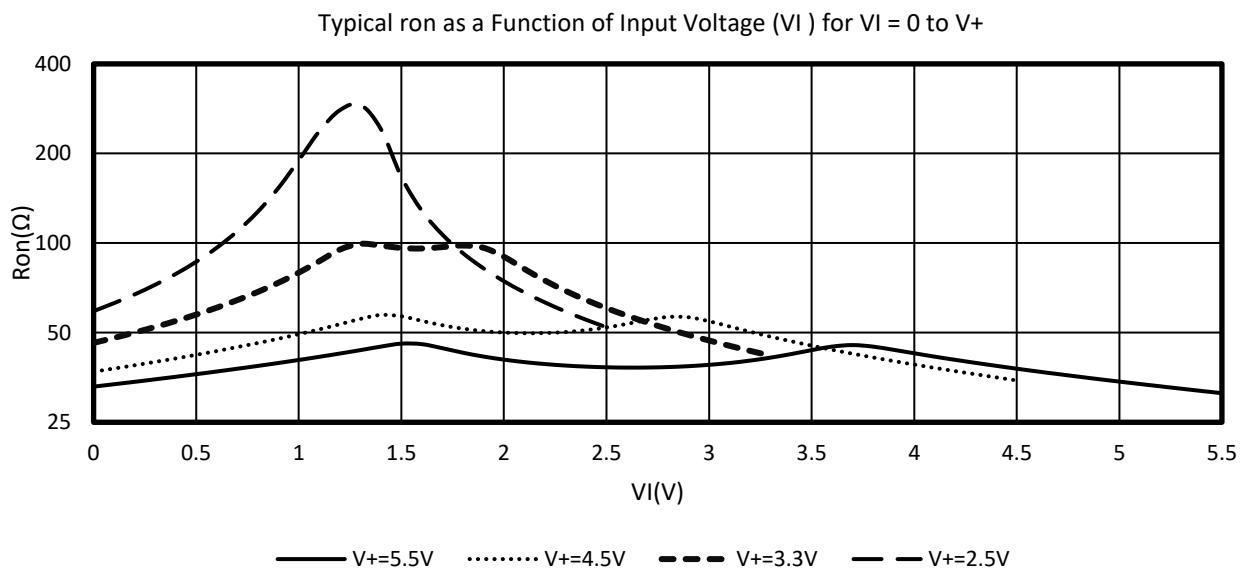
(1) All unused digital inputs of the device must be held at  $V_{IO}$  or GND to ensure proper device operation.

## ELECTRICAL CHARACTERISTICS (continued)

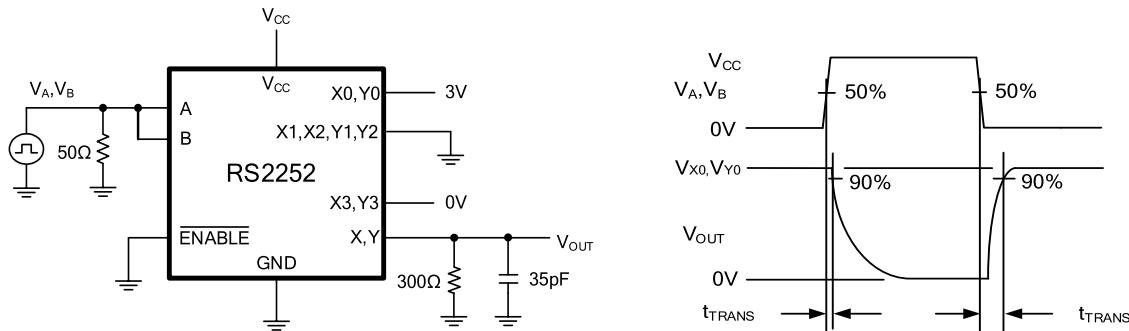
V<sub>CC</sub>= 5.0 V or 3.3V, FULL= -40°C to +125°C Typical values are at TA = +25°C (unless otherwise noted)

PARAMETER	SYMBOL	CONDITIONS	V <sub>CC</sub>	TEMP	MIN	TYP	MAX	UNITS
<b>DYNAMIC CHARACTERISTICS</b>								
Address Transition Time	t <sub>TRANS</sub>	V <sub>X</sub> , V <sub>Y</sub> = 3V/0V, R <sub>L</sub> = 300Ω, C <sub>L</sub> = 35pF, Test Circuit 1	5V	+25°C		120		ns
		V <sub>X</sub> , V <sub>Y</sub> = 3V/0V, R <sub>L</sub> = 300Ω, C <sub>L</sub> = 35pF, Test Circuit 1	3.3V	+25°C		210		ns
ENABLE Turn-On Time	t <sub>ON</sub>	V <sub>X</sub> , V <sub>Y</sub> = 3V, R <sub>L</sub> = 300Ω, C <sub>L</sub> = 35pF, Test Circuit 2	5V	+25°C		70		ns
			3.3V			130		
ENABLE Turn-Off Time	t <sub>OFF</sub>	V <sub>X</sub> , V <sub>Y</sub> = 3V, R <sub>L</sub> = 300Ω, C <sub>L</sub> = 35pF, Test Circuit 2	5V	+25°C		80		ns
			3.3V			120		
Internal A, B, C Rise Time	t <sub>R</sub>		5V	+25°C		50		ns
			3.3V			80		
Internal A, B, C Fall Time	t <sub>F</sub>		5V	+25°C		60		ns
			3.3V			85		ns
Break-Before-Make Time Delay	t <sub>D</sub>	V <sub>X</sub> , V <sub>Y</sub> = 3V, R <sub>L</sub> = 300Ω, C <sub>L</sub> = 35pF, Test Circuit 3	5V	+25°C		50		ns
			3.3V			80		ns
Charge Injection	Q	R <sub>S</sub> = 0Ω, C <sub>L</sub> = 1nF, Test Circuit 4	5V	+25°C		6		pC
		R <sub>S</sub> = 0Ω, C <sub>L</sub> = 1nF, Test Circuit 4	3.3V			4		pC
Crosstalk	X <sub>TALK</sub>	f = 1MHz, Test Circuit 5	5V	+25°C		-110		dB
Off Isolation	O <sub>ISO</sub>	R <sub>L</sub> = 50Ω, f = 1MHz, Test Circuit 5	5V	+25°C		-83		dB
-3dB Bandwidth	BW	R <sub>L</sub> = 50Ω	5V	+25°C		180		MHz
			3.3V			180		MHz
Input Off-Capacitance	C <sub>X(OFF)</sub> C <sub>X(OFF)</sub>	f = 1MHz, Test Circuit 6	5V	+25°C		4.7		pF
Output Off-Capacitance	C <sub>X(OFF)</sub> C <sub>Y(OFF)</sub>	f = 1MHz, Test Circuit 6	5V	+25°C		12.7		pF
Output On- Capacitance	C <sub>X(ON)</sub> C <sub>Y(ON)</sub>	f = 1MHz, Test Circuit 6	5V	+25°C		16		pF
Total Harmonic Distortion	THD	R <sub>L</sub> = 600Ω, 5V <sub>P-P</sub> , f = 20Hz to 20kHz	5V	+25°C		0.7		%
<b>POWER REQUIREMENTS</b>								
Power Supply Range	V <sub>CC</sub>			FULL	2.5		5.5	V
Power Supply Current	I <sub>CC</sub>	V <sub>CC</sub> = 5.0V, V <sub>A</sub> , V <sub>B</sub> , V <sub>ENABLE</sub> = V <sub>CC</sub> or 0	5V	+25°C		0.001	2	μA
		V <sub>CC</sub> = 3.3V, V <sub>A</sub> , V <sub>B</sub> , V <sub>ENABLE</sub> = V <sub>CC</sub> or 0	3.3V	+25°C		0.001	1	μA

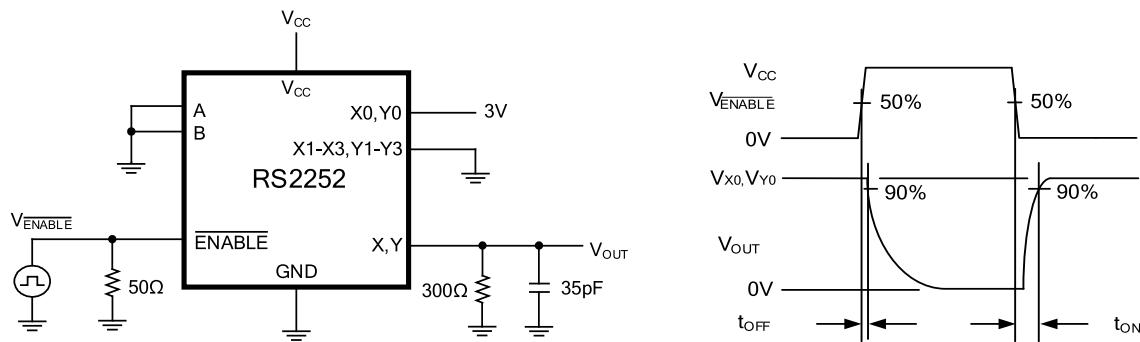
## TYPICAL CHARACTERISTICS



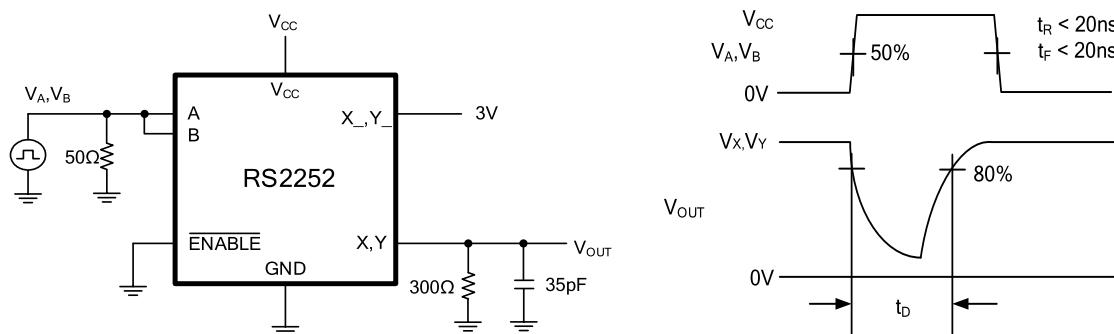
## Parameter Measurement Information



**Test Circuit 1. Address Transition Times ( $t_{TRANS}$ )**

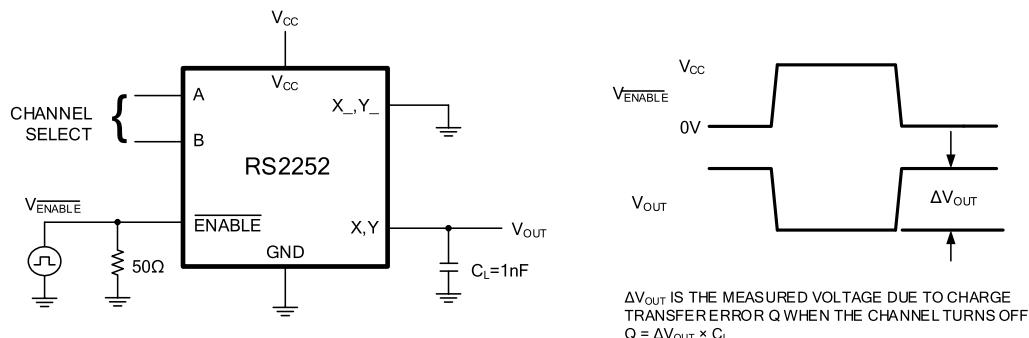


**Test Circuit 2. Switching Times ( $t_{ON}$ ,  $t_{OFF}$ )**

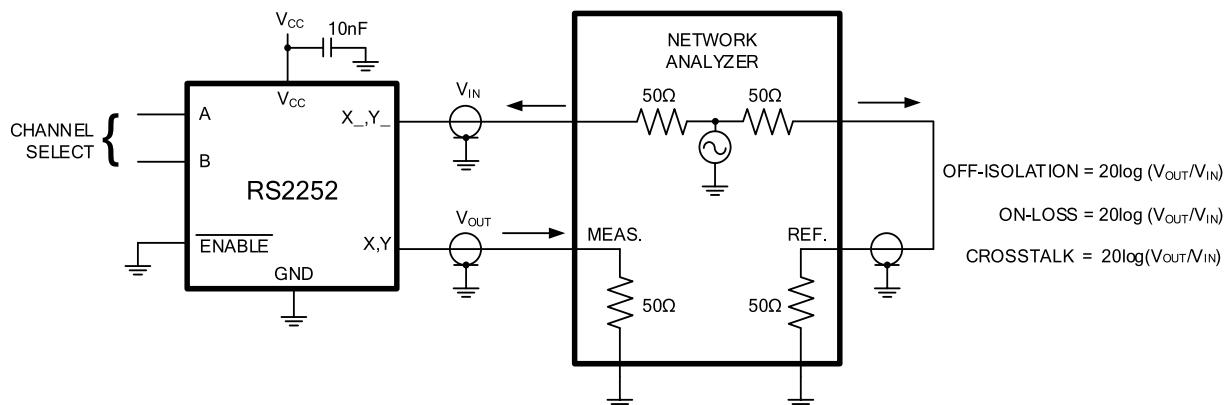


**Test Circuit 3. Break-Before-Make Time Delay ( $t_D$ )**

## Parameter Measurement Information (continued)

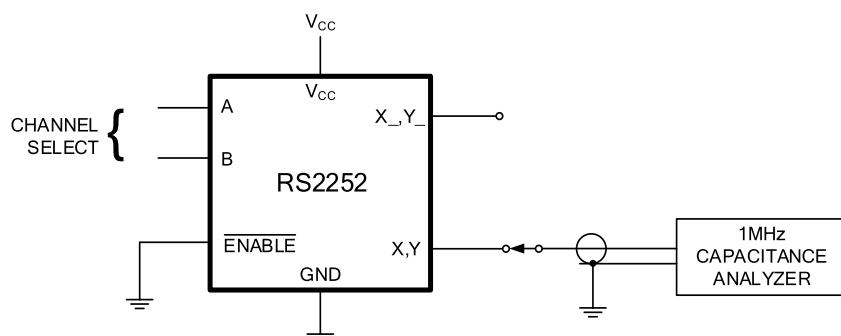


## Test Circuit 4. Charge Injection (Q)



MEASUREMENTS ARE STANDARDIZED AGAINST SHORT AT SOCKET TERMINALS.  
 OFF-ISOLATION IS MEASURED BETWEEN COM AND "OFF" NO TERMINAL ON EACH SWITCH.  
 ON-LOSS IS MEASURED BETWEEN COM AND "ON" NO TERMINAL ON EACH SWITCH.  
 SIGNAL DIRECTION THROUGH SWITCH IS REVERSED; WORST VALUES ARE RECORDED.

## Test Circuit 5. Off Isolation, On Loss

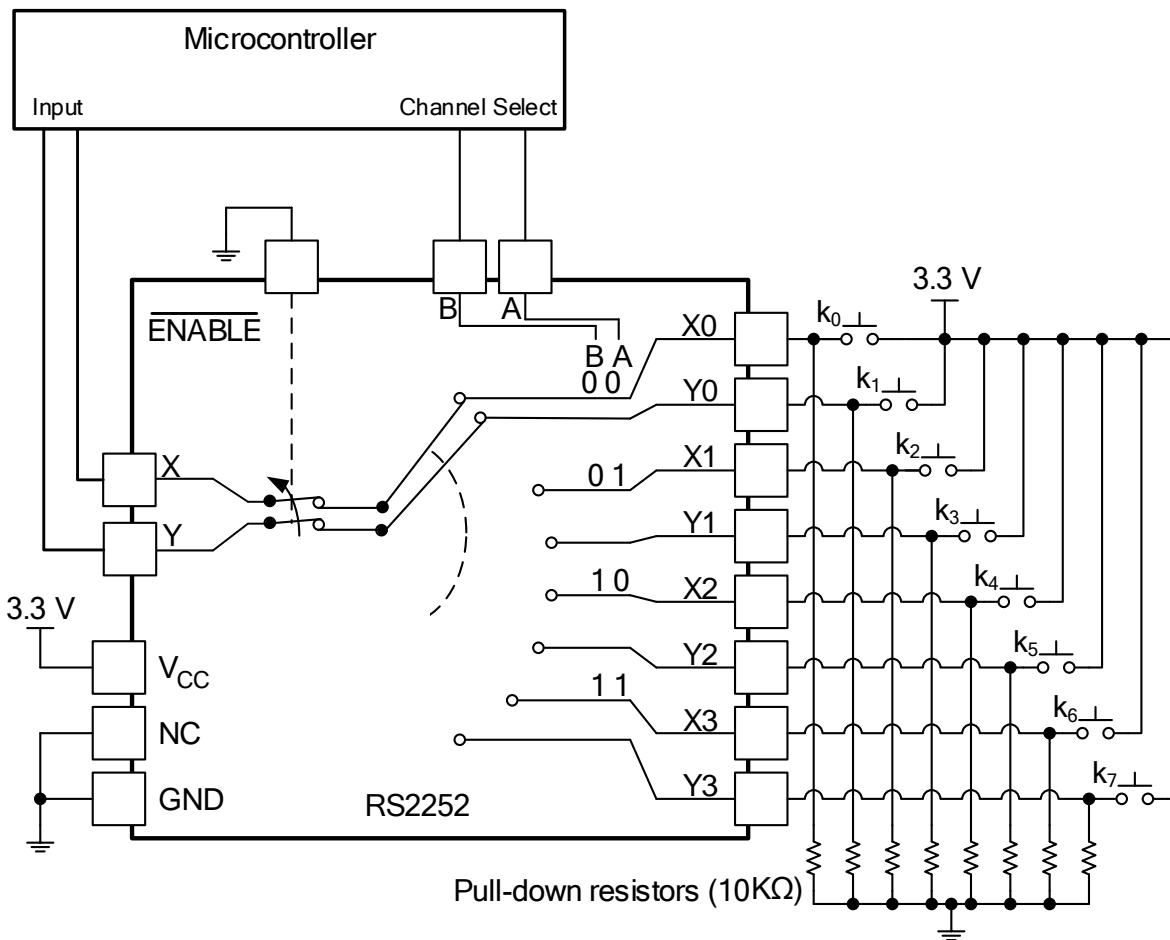


## Test Circuit 6. Capacitance

## APPLICATION NOTES

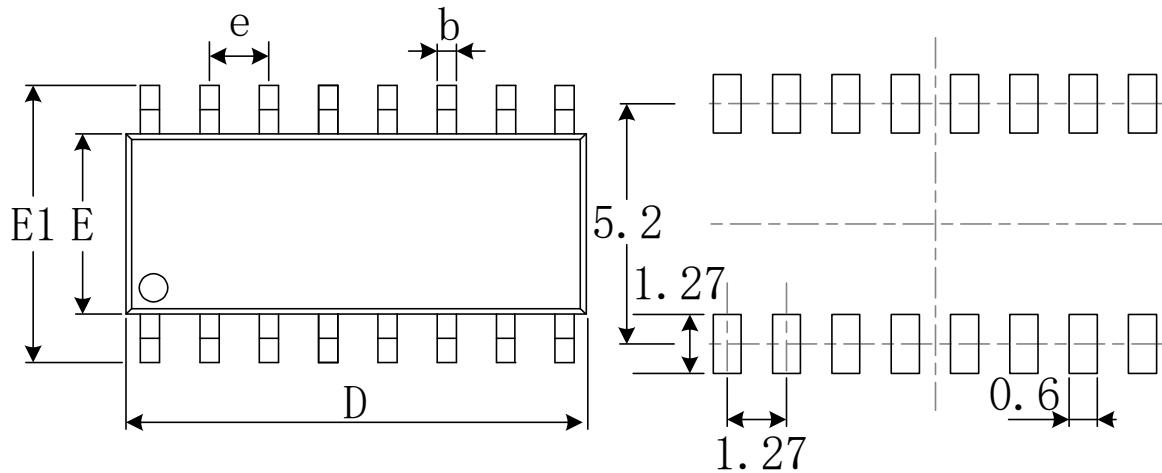
The RS2252 device is a differential 4-channel multiplexer having two binary control inputs, A and B, and an inhibit input. The two binary input signals select 1 of 4 pairs of channels to be turned on and connect the analog inputs to the outputs.

One application of the RS2252 is to use it in conjunction with a microcontroller to poll a keypad. Figure 1 shows the basic schematic for such a polling system. The microcontroller uses the channel select pins to cycle through the different channels while reading the input to see if a user is pressing any of the keys. This is a very robust setup, allowing for multiple simultaneous key-presses with very little power consumption. It also utilizes very few pins on the microcontroller. The down side of polling is that the microcontroller must continually scan the keys for a press and can do little else during this process.

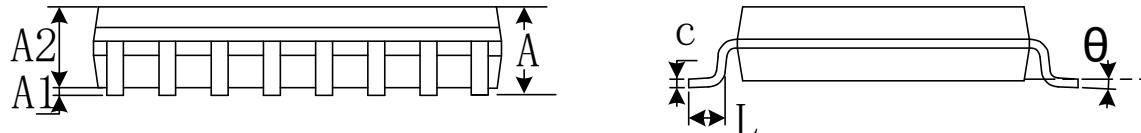


**Figure 1. The RS2252 Being Used to Help Read Button Presses on a Keypad.**

## PACKAGE OUTLINE DIMENSIONS SOIC-16

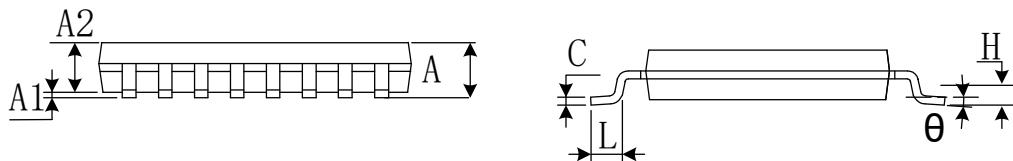
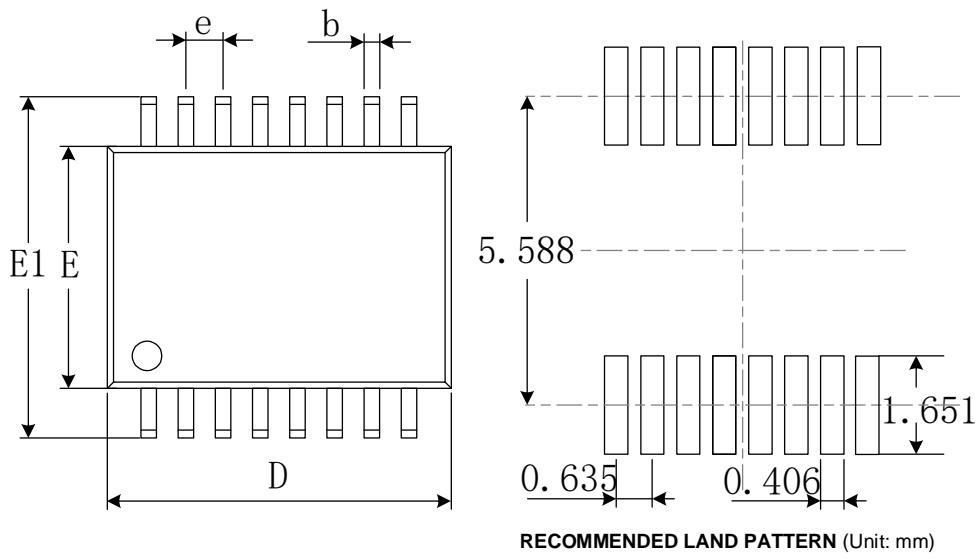


**RECOMMENDED LAND PATTERN (Unit: mm)**



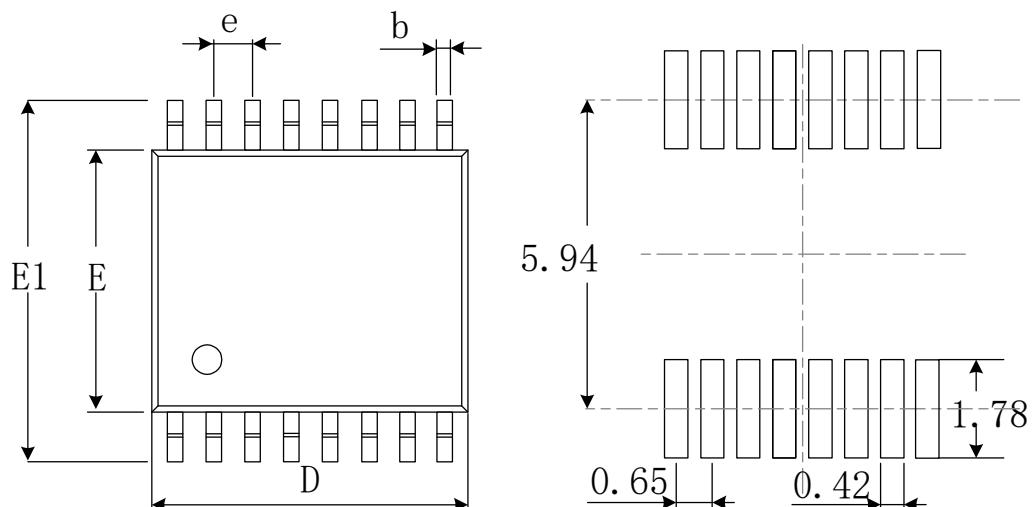
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.006	0.010
D	9.800	10.200	0.386	0.402
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.27(BSC)		0.050(BSC)	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

## SSOP-16

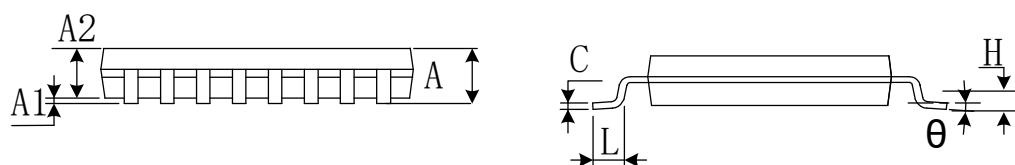


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.200	0.300	0.008	0.012
c	0.170	0.250	0.007	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	0.635(BSC)		0.025(BSC)	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

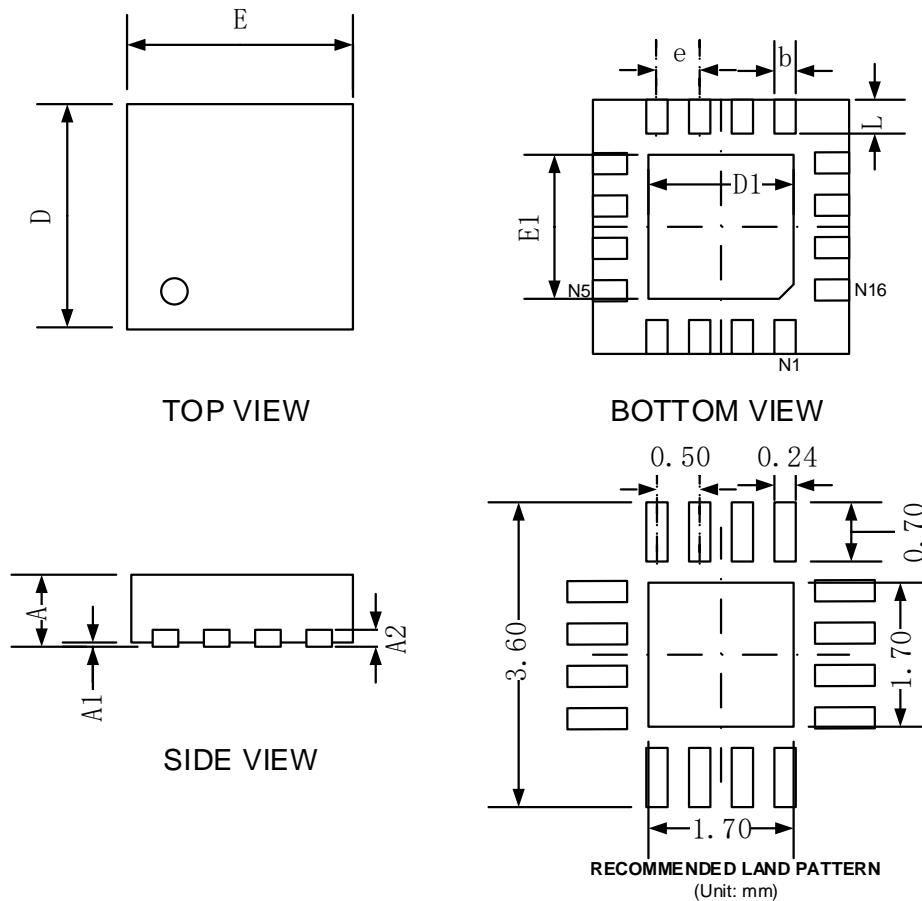
## TSSOP-16



RECOMMENDED LAND PATTERN (Unit: mm)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A		1.200		0.047
A1	0.050	0.150	0.002	0.006
A2	0.800	1.050	0.031	0.041
b	0.190	0.300	0.007	0.012
c	0.090	0.200	0.004	0.008
D	4.860	5.100	0.191	0.201
E	4.300	4.500	0.169	0.177
E1	6.200	6.600	0.244	0.260
e	0.650(BSC)		0.026(BSC)	
L	0.500	0.700	0.02	0.028
H	0.25TYP		0.01TYP	
θ	1°	7°	1°	7°

**QFN-3x3-16L**


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.700	0.800	0.028	0.031
A1	0.000	0.050	0.000	0.002
A2	0.203		0.008	
b	0.180	0.300	0.007	0.012
D	2.900	3.100	0.114	0.122
D1	1.600	1.800	0.063	0.071
E	2.900	3.100	0.114	0.122
E1	1.600	1.800	0.063	0.071
e	0.500 TYP		0.020 TYP	
L	0.300	0.500	0.012	0.020